

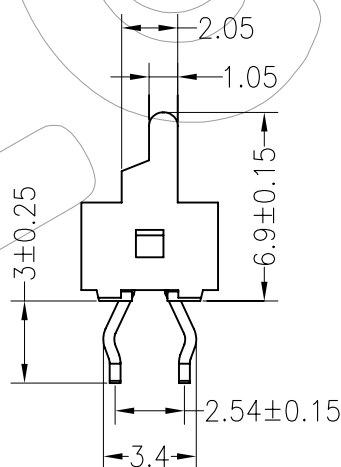
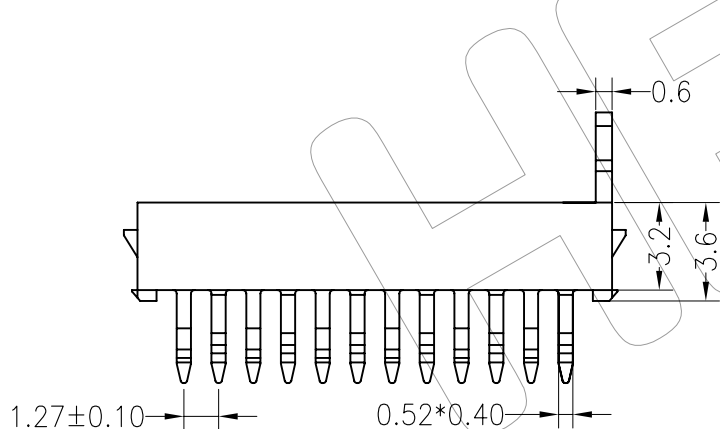
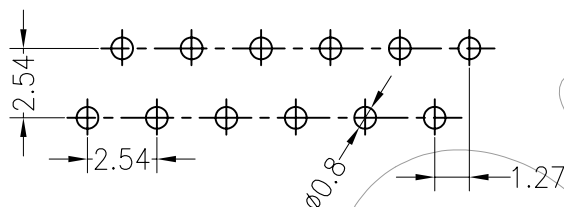
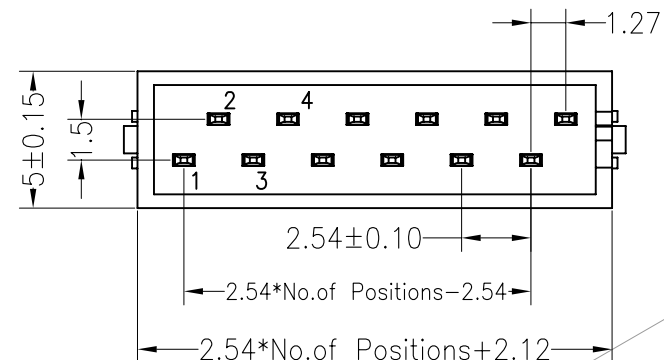
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40 $^{\circ}$ c to +105 $^{\circ}$ c

Contact Material:Brass
Contact Plating:Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA46
Max.Processing Temp: 230 $^{\circ}$ C for 30-60 seconds
(260 $^{\circ}$ C for 10 seconds)



Ordering Information

HC-MH XX M S SN X N X 01

No.of Pins: 04~26P
Contact Plating: S0:Gold Flash/Tin, SN:Tin
Insulator Material Option: A=BK-PBT, D=BK-PA46
Packing: T=Tube, R=Reel

OPERATION

X.X ± 0.30
X.XX ± 0.20
X.XXX ± 0.10
Angle $\pm 3^{\circ}$
DIM TOL

DRAW

Ayang

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

Φ ∇

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-MHXXMSSNXNX01

TITLE:

Micro Match Connector Male 180 $^{\circ}$